

# PATENT ASSIGNMENT

Electronic Version v1.1

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Lap Shun Lo	08/27/2009
Wai Chung Lo	08/27/2009
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	Wing Hing Manufacturing Co. Ltd.
<b>Street Address:</b>	Block K, 19/F, Stage 2, Superluck Industrial Bldg.
<b>Internal Address:</b>	57 Sha Tsui Road, Tsuen Wan
<b>City:</b>	Hong Kong
<b>State/Country:</b>	CHINA
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	29341789
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(713)427-5099
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
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<b>Correspondent Name:</b>	Michael Dai
<b>Address Line 1:</b>	711 Louisiana, Suite 3400
<b>Address Line 4:</b>	Houston, TEXAS 77002
<b>ATTORNEY DOCKET NUMBER:</b>	32009442.000043
<b>NAME OF SUBMITTER:</b>	Michael Dai
<b>Total Attachments: 2</b> source=43_Assignment#page1.tif source=43_Assignment#page2.tif	

OP \$40.00 29341789

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**PATENT**  
**REEL: 023169 FRAME: 0670**

## **ASSIGNMENT**

WHEREAS, we, Lap Shun Lo and Wai Chung Lo, have designed and invented certain new and useful improvements in the following:

### **WAND**

for which we have filed an application for United States Design Patent on **August 12, 2009**, Serial No.: **29/341789**;

WHEREAS, Wing Hing Manufacturing Co Ltd, having its principal place of business at Block K, 19/F, Stage 2, Superluck Industrial Building, 57 Sha Tsui Road, Tsuen Wan, Hong Kong, China (hereinafter referred to as "ASSIGNEE"), is desirous of acquiring our entire right, title and interest in and to the invention, and in and to the said application and any Patent that may issue thereon;

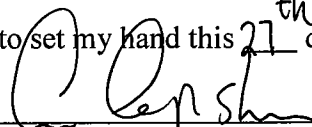
NOW, THEREFORE, for and in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we do hereby sell, assign and transfer unto ASSIGNEE, its successors, assigns and legal representatives our entire right, title and interest in and to said invention and in and to said applications and all patents which may be granted therefore, and all divisions, reissues, substitutions, continuations, continuation-in-part and extensions thereof; and we hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patents resulting therefrom, insofar as our interest is concerned, to the said ASSIGNEE of our entire right, title and interest.

We also hereby sell and assign to said ASSIGNEE, its successors, assigns and legal representatives the full and exclusive rights, title and interest to the invention disclosed in said applications throughout the world, including the right to file applications and obtain patents, utility models, industrial models and designs for said invention in its own name throughout the world including all rights of priority, all rights to publish cautionary notices reserving ownership of said invention and all rights to register said invention in appropriate registries; and

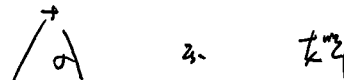
We further agree to execute any and all powers of attorney, applications, assignments, declarations, affidavits, and any other papers in connection therewith necessary to perfect such rights, title and interest in ASSIGNEE, its successors, assigns and legal representatives.

We hereby further agree that we will communicate to said ASSIGNEE, or its successors, assigns and legal representatives, any facts known to us respecting any improvements; and, at the expense of said ASSIGNEE, to testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, continuation-in-part, reissue and substitute applications, make all lawful oaths, and generally do everything possible to vest title in said ASSIGNEE and to aid said ASSIGNEE, its successors, assigns and legal representatives to obtain and enforce proper protection for said invention in all countries.

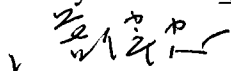
IN WITNESS WHEREOF, I have hereunto set my hand this 27<sup>th</sup> day of Aug, 2009.

  
\_\_\_\_\_  
Name: Lap Shun Lo  
Address: Blk. K, 19/F, Phase 2, Superluck Ind. Bldg.  
57 Sha Tsui Road, Tsuen Wan,  
Hong Kong, China

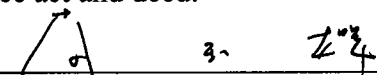
On this 27<sup>th</sup> day of August, 2009, before me, personally appeared Lap Shun Lo, known by me to be the person of the above name who signed the foregoing instrument, and acknowledged the same to be his own free act and deed.

  
\_\_\_\_\_  
Witness Name: Yuk Sim Li

IN WITNESS WHEREOF, I have hereunto set my hand this 27<sup>th</sup> day of Aug, 2009.

  
\_\_\_\_\_  
Name: Wai Chung Lo  
Address: Blk. K, 19/F, Phase 2, Superluck Ind. Bldg.  
57 Sha Tsui Road, Tsuen Wan,  
Hong Kong, China

On this 27<sup>th</sup> day of August, 2009, before me, personally appeared Wai Chung Lo, known by me to be the person of the above name who signed the foregoing instrument, and acknowledged the same to be his own free act and deed.

  
\_\_\_\_\_  
Witness Name: Yuk Sim Li